

Flooring

CompactFloor® BASE 12

Lay CompactFloor® BASE 12 according to installation instructions. Leave adhesive to cure completely and keep surface free of dust. Process recommended flooring according to manufacturer's instructions with released adhesives (see datasheet „material releases“).

Parquet / Laminate	8 mm mosaic block / herringbone	8 mm solid english bond straight / ladder pattern	
	2- or 3-layer ready-made parquet parquet plank / country style single plank	2- or 3-layer ready-made parquet short format less than 100 cm	
	22 mm on-edge lamel parquet	22 mm strip parquet and solid parquet up to 2,70 m	
	Laminate (Manufacturer release for full-surface bonding required)		
Tiles / Natural stone	Ceramic tiles / Porcelain stoneware Tile size: max. 60 x 60 cm Aspect ratio: 1:1 to 3:1 Minimum thickness: 9 mm Breaking strength: min. 1.500 N Technical joint width: min. 3 mm	Natural stones Tile size: max. 60 x 60 cm Aspect ratio: 1:1 to 3:1 Minimum thickness: 15 mm Breaking strength: min. 1.500 N Technical joint width: min. 3 mm	
	When laying ceramic floor coverings or natural stones on CompactFloor BASE 12, dispersion joints must be used: Dispersion joint Kiesel Oka Color (Kiesel Bauchemie GmbH u. Co. KG) or Dispersion joint Esco® 1K (ESCO-Fuge GmbH & CO. KG) Cement joints are not suitable!		
Textile / Elastic floor coverings	Textile coverings	PVC / CV coverings design coverings	Needle punched flooring

Material release

CompactFloor® BASE 12

Attention: Lay CompactFloor® BASE 12 according to installation instructions. Leave adhesive to cure completely and keep surface free of dust. Process recommended products in accordance with manufacturer's instructions and the generally acknowledged rules of technology.

Parquet	8 mm mosaic block / herringbone	8 mm solid english bond straight / ladder pattern	2- or 3-layer ready-made parquet short format less than 100 cm	2- or 3-layer ready-made parquet parquet plank / country style single plank	22 mm strip parquet and solid parquet up to 2,70 m*	22 mm on-edge lamel parquet	Laminate (for full-surface bonding)*
Adhesive	Bakit EK new						
Uncoupling fabric	not necessary	Okavlies	not necessary	not necessary	Okavlies	Okavlies	not necessary
If required	Primer on leveling compound	no primer					
	Leveling compound	<p>Servoalpha AF 1000 max. 5 mm</p> <p>When using the said compensatory casting compound, instead of the Okamul PU-V schnell, one of the following primers has to be used below the compound: Okatmos EG 20, 1:1 diluted with water or Okatmos UG 30, 1:1 diluted with water</p>					
Primer for direct bonding to CompactFloor	Okamul PU-V schnell (if required)						

Tiles / Natural stones	Ceramic tiles / Porcelain stoneware	Natural stones
	<p>Tile size: max. 60 x 60 cm spect ratio: 1:1 bis 3:1 Minimum thickness: 9 mm Breaking strength: mind. 1500 N Technical joint width: mind. 3 mm</p>	<p>Tile size: max. 60 x 60 cm spect ratio: 1:1 bis 3:1 Minimum thickness: 15 mm Breaking strength: mind. 1500 N Technical joint width: mind. 3 mm</p>
Joint mortar Test jointing recommended	Dispersion joint Oka Color	
Adhesive	Servoflex Trio SuperTec / Servoflex-Trio-schnell SuperTec	
Uncoupling fabric	not necessary	
If required	Sealing in damp rooms	<p>Servoflex DMS 1K Plus SuperTec</p> <p>When using said leveling compound, a primer should be used under the leveling compound: Okatmos DSG, 1:1 diluted with water</p>
	Primer on leveling compound	Okatmos DSG , 1:1 diluted with water
	Leveling compound	<p>Servoalpha AF 1000 max. 5 mm</p> <p>When using said leveling compound, a primer should be used under the leveling compound: 1. Auftrag: Okatmos DSG, 1:1 mit Wasser verdünnt 2. Auftrag: Okatmos DSG, pur</p>
Primer for direct bonding to CompactFloor	<p>1. cover: Okatmos DSG, 1:1 diluted with water 2. cover: Okatmos DSG, pure</p>	

Textile / Elastic floor coverings	Textile coverings	PVC / CV coverings design coverings	Needle punched flooring
Adhesive	Okatmos ET6	Okatmos Star 100 / 110 / 120	Okatmos EN 30
Primer on leveling compound	no primer		
Leveling compound	Servoalpha AF 1000 max. 5 mm		
	<p>When using said leveling compound, a primer should be used under the leveling compound: Okatmos EG 20, 1:1 diluted with water or Okatmos UG 30, 1:1 diluted with water</p>		